

Features

- High-speed: 35, 70 ns
- Ultra low DC operating current of 5mA (max.)
 TTL Standby: 5 mA (Max.)
 CMOS Standby: 60 μ A (Max.)
- Fully static operation
- All inputs and outputs directly compatible
- Three state outputs
- Ultra low data retention current ($V_{CC} = 2V$)
- Single 5V \pm 10% Power Supply

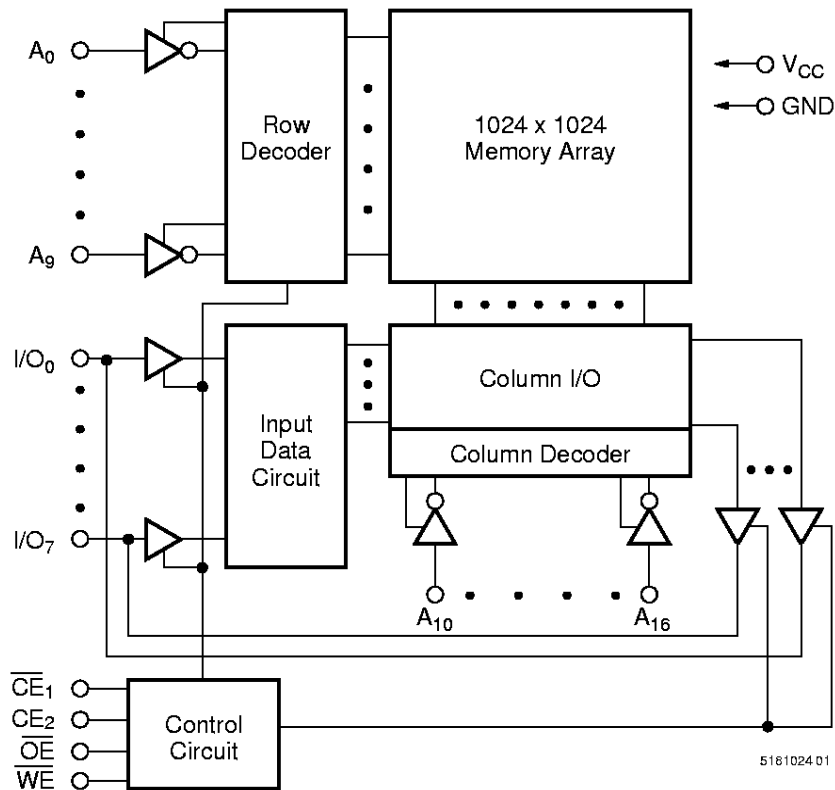
■ Packages

- 32-pin TSOP (Standard)
- 32-pin 600 mil PDIP
- 32-pin 440 mil SOP (525 mil pin-to-pin)

Description

The V62C5181024 is a 1,048,576-bit static random-access memory organized as 131,072 words by 8 bits. It is built with MOSEL VITELIC's high performance CMOS process. Inputs and three-state outputs are TTL compatible and allow for direct interfacing with common system bus structures.

Functional Block Diagram



Device Usage Chart

Operating Temperature Range	Package Outline			Access Time (ns)		Power		Temperature Mark
	T	W	P	35	70	L	LL	
0°C to 70 °C	•	•	•	•	•	•	•	Blank
-40°C to +85°C	•	•	•	•	•	•	•	I

Pin Descriptions

A₀-A₁₆ Address Inputs

These 17 address inputs select one of the 128K x 8 bit segments in the RAM.

\overline{CE}_1 , CE₂ Chip Enable Inputs

\overline{CE}_1 is active LOW and CE₂ is active HIGH. Both chip enables must be active to read from or write to the device. If either chip enable is not active, the device is deselected and is in a standby power mode. The I/O pins will be in the high-impedance state when deselected.

\overline{OE} Output Enable Input

The Output Enable input is active LOW. When \overline{OE} is LOW with \overline{CE} LOW and WE HIGH, data of the selected memory location will be available on the I/O pins. When \overline{OE} is HIGH, the I/O pins will be in the high impedance state.

\overline{WE} Write Enable Input

An active LOW input, WE input controls read and write operations. When CE and WE inputs are both LOW, the data present on the I/O pins will be written into the selected memory location.

I/O₀-I/O₇ Data Input and Data Output Ports

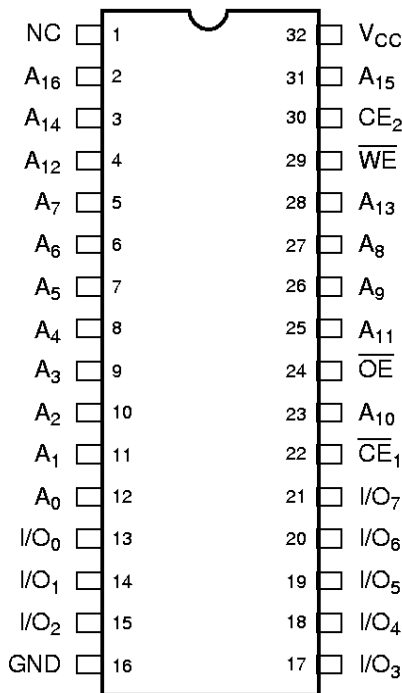
These 8 bidirectional ports are used to read data from and write data into the RAM.

V_{CC} Power Supply

GND Ground

Pin Configurations (Top View)

32-Pin DIP/SOP



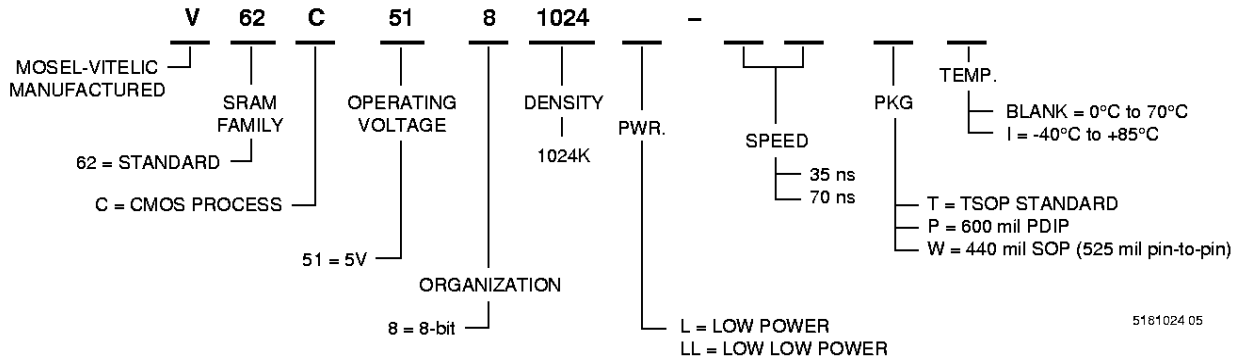
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32-Pin TSOP (Standard)



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Part Number Information



Absolute Maximum Ratings (1)

Symbol	Parameter	Commercial	Industrial	Units
V _{CC}	Supply Voltage	-0.5 to +7	-0.5 to +7	V
V _N	Input Voltage	-0.5 to +7	-0.5 to +7	V
V _{DQ}	Input/Output Voltage Applied	V _{CC} + 0.5	V _{CC} + 0.5	V
T _{BIAS}	Temperature Under Bias	-10 to +125	-65 to +135	°C
T _{STG}	Storage Temperature	-55 to +125	-65 to +150	°C

NOTE:

- Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Capacitance*

T_A = 25°C, f = 1.0MHz

Symbol	Parameter	Conditions	Max.	Unit
C _{IN}	Input Capacitance	V _{IN} = 0V	6	pF
C _{OUT}	Output Capacitance	V _{I/O} = 0V	8	pF

NOTE:

- This parameter is guaranteed and not tested.

Truth Table

Mode	\overline{CE}_1	CE ₂	\overline{OE}	WE	I/O Operation
Standby	H	X	X	X	High Z
Standby	X	L	X	X	High Z
Output Disable	L	H	H	H	High Z
Read	L	H	L	H	D _{OUT}
Write	L	H	X	L	D _{IN}

NOTE:

X = Don't Care, L = LOW, H = HIGH

DC Electrical Characteristics (over all temperature ranges, $V_{CC} = 5V \pm 10\%$)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{IL}	Input LOW Voltage ^(1,2)		-0.5	—	0.8	V
V_{IH}	Input HIGH Voltage ⁽¹⁾		2.2	—	6	V
I_{IL}	Input Leakage Current	$V_{CC} = \text{Max}, V_{IN} = 0V \text{ to } V_{CC}$	-5	—	5	μA
I_{OL}	Output Leakage Current	$V_{CC} = \text{Max}, \overline{CE}_1 = V_{IH}, V_{OUT} = 0V \text{ to } V_{CC}$	-5	—	5	μA
V_{OL}	Output LOW Voltage	$V_{CC} = \text{Min}, I_{OL} = 2.1\text{mA}$	—	—	0.4	V
V_{OH}	Output HIGH Voltage	$V_{CC} = \text{Min}, I_{OH} = -1\text{mA}$	2.4	—	—	V

Symbol	Parameter	Power	Com. ⁽⁴⁾	Ind. ⁽⁴⁾	Units	
I_{CC}	Operating Power Supply Current, $\overline{CE}_1 = V_{IL}, CE_2 = V_{IH}$, Output Open, $V_{CC} = \text{Max.}, f = 0$	Read	L	4	6	mA
			LL	3	5	
		Write	L	30	35	
			LL	25	30	
I_{CC1}	Average Operating Current, $\overline{CE}_1 = V_{IL}, CE_2 = V_{IH}$, Output Open, $V_{CC} = \text{Max.}, f = f_{MAX}^{(3)}$		80	90	mA	
I_{SB}	TTL Standby Current $\overline{CE}_1 \geq V_{IH}, CE_2 \leq V_{IL}, V_{CC} = \text{Max.}$	L	4	6	mA	
		LL	3	5		
I_{SB1}	CMOS Standby Current, $\overline{CE}_1 \geq V_{CC} - 0.2V, CE_2 \leq 0.2V,$ $V_{IN} \geq V_{CC} - 0.2V \text{ or } V_{IN} \leq 0.2V, V_{CC} = \text{Max.}$	L	60	80	μA	
		LL	50	60		

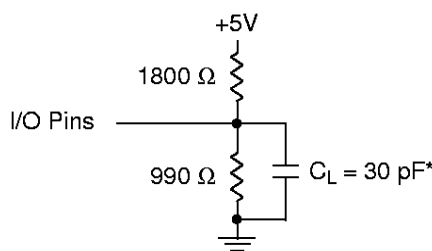
NOTES:

- These are absolute values with respect to device ground and all overshoots due to system or tester noise are included.
- V_{IL} (Min.) = -3.0V for pulse width < 20ns.
- $f_{MAX} = 1/t_{RC}$.
- Maximum values.

AC Test Conditions

Input Pulse Levels	0 to 3V
Input Rise and Fall Times	5 ns
Timing Reference Levels	1.5V
Output Load	see below

AC Test Loads and Waveforms



* Includes scope and jig capacitance

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Key to Switching Waveforms

WAVEFORM	INPUTS	OUTPUTS
	MUST BE STEADY	WILL BE STEADY
	MAY CHANGE FROM H TO L	WILL BE CHANGING FROM H TO L
	MAY CHANGE FROM L TO H	WILL BE CHANGING FROM L TO H
	DON'T CARE: ANY CHANGE PERMITTED	CHANGING: STATE UNKNOWN
	DOES NOT APPLY	CENTER LINE IS HIGH IMPEDANCE "OFF" STATE

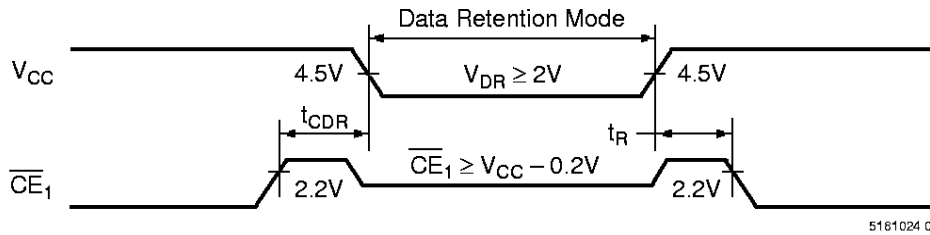
Data Retention Characteristics

Symbol	Parameter	Power	Min.	Typ. ⁽²⁾	Max.	Units	
V_{DR}	V_{CC} for Data Retention $\overline{CE}_1 \geq V_{CC} - 0.2V, CE_2 \leq 0.2V,$ $V_{IN} \geq V_{CC} - 0.2V, \text{ or } V_{IN} \leq 0.2V$		2.0	—	5.5	V	
I_{CCDR}	Data Retention Current $\overline{CE}_1 \geq V_{DR} - 0.2V, CE_2 \leq 0.2V,$ $V_{IN} \geq V_{CC} - 0.2V, \text{ or } V_{IN} \leq 0.2V$	Com'l	L	—	2	50	μA
			LL	—	2	40	
		Ind.	L	—	—	100	
			LL	—	4	60	
t_{CDR}	Chip Deselect to Data Retention Time		0	—	—	ns	
t_R	Operation Recovery Time (see Retention Waveform)		$t_{RC}^{(1)}$	—	—	ns	

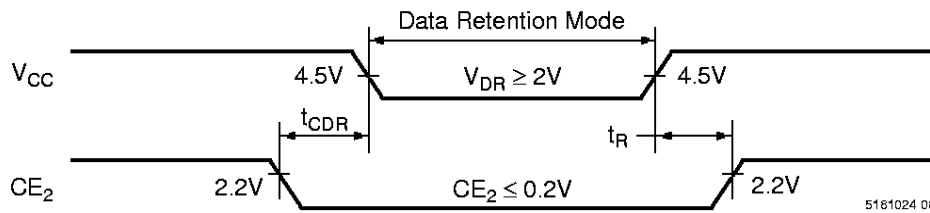
NOTES:

- t_{RC} = Read Cycle Time
- $T_A = +25^\circ C.$

Low V_{CC} Data Retention Waveform (1) (\overline{CE}_1 Controlled)



Low V_{CC} Data Retention Waveform (2) (CE_2 Controlled)



AC Electrical Characteristics

(over all temperature ranges)

Read Cycle

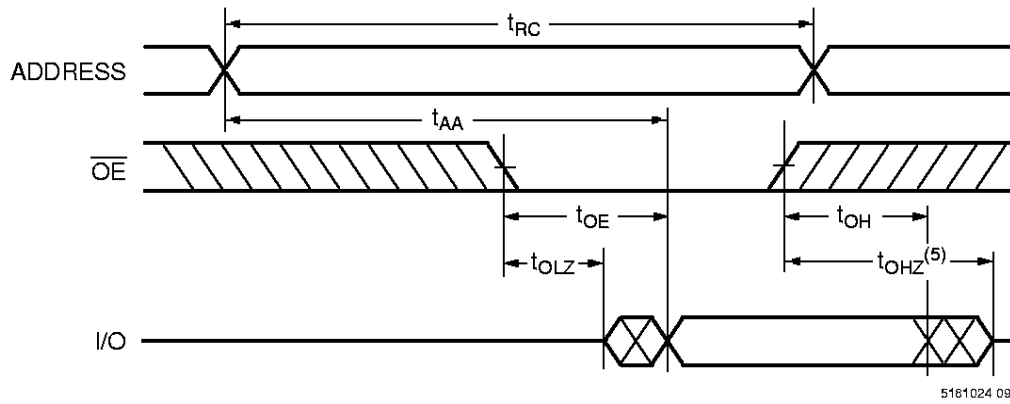
Parameter Name	Parameter	-35		-45		-55		-70		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t_{RC}	Read Cycle Time	35	—	45	—	55	—	70	—	ns
t_{AA}	Address Access Time	—	35	—	45	—	55	—	70	ns
t_{ACS1}	Chip Enable Access Time	—	35	—	45	—	55	—	70	ns
t_{ACS2}	Chip Enable Access Time	—	35	—	45	—	55	—	70	ns
t_{OE}	Output Enable to Output Valid	—	10	—	20	—	25	—	35	ns
t_{CLZ1}	Chip Enable to Output in Low Z	3	—	5	—	7	—	10	—	ns
t_{CLZ2}	Chip Enable to Output in Low Z	3	—	5	—	7	—	10	—	ns
t_{OLZ}	Output Enable to Output in Low Z	5	—	5	—	5	—	5	—	ns
t_{CHZ}	Chip Disable to Output in High Z	0	10	0	15	0	20	0	25	ns
t_{OHZ}	Output Disable to Output in High Z	0	10	0	15	0	20	0	25	ns
t_{OH}	Output Hold from Address Change	3	—	3	—	3	—	3	—	ns

Write Cycle

Parameter Name	Parameter	-35		-45		-55		-70		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t_{WC}	Write Cycle Time	35	—	45	—	55	—	70	—	ns
t_{CW1}	Chip Enable to End of Write	25	—	35	—	50	—	60	—	ns
t_{CW2}	Chip Enable to End of Write	25	—	35	—	50	—	60	—	ns
t_{AS}	Address Setup Time	0	—	0	—	0	—	0	—	ns
t_{AW}	Address Valid to End of Write	25	—	35	—	45	—	60	—	ns
t_{WP}	Write Pulse Width	25	—	35	—	40	—	50	—	ns
t_{WR}	Write Recovery Time	0	—	0	—	0	—	0	—	ns
t_{WHZ}	Write to Output High-Z	0	10	0	15	0	20	0	25	ns
t_{WLZ}	Write to Output Low Z	3	—	5	—	5	—	5	—	ns
t_{DW}	Data Setup to End of Write	20	—	25	—	25	—	30	—	ns
t_{DH}	Data Hold from End of Write	0	—	0	—	0	—	0	—	ns

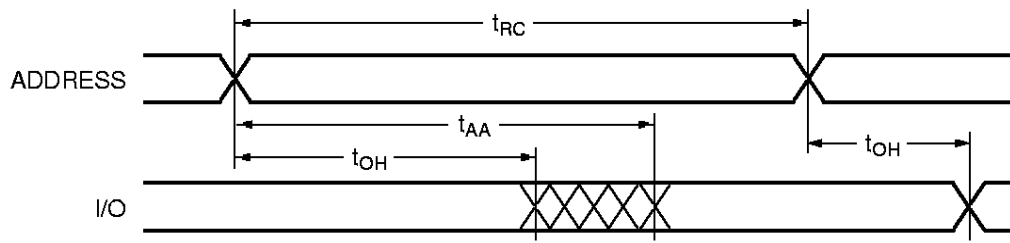
Switching Waveforms (Read Cycle)

Read Cycle 1^(1, 2)



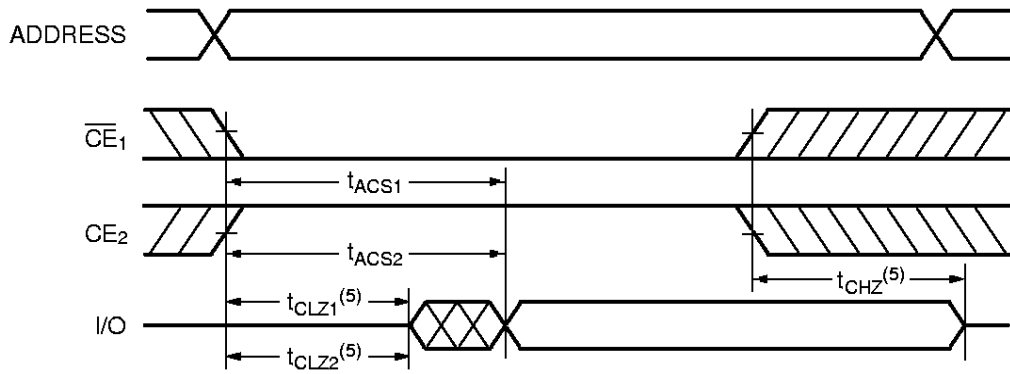
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Read Cycle 2^(1, 2, 4)



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Read Cycle 3^(1, 3, 4)



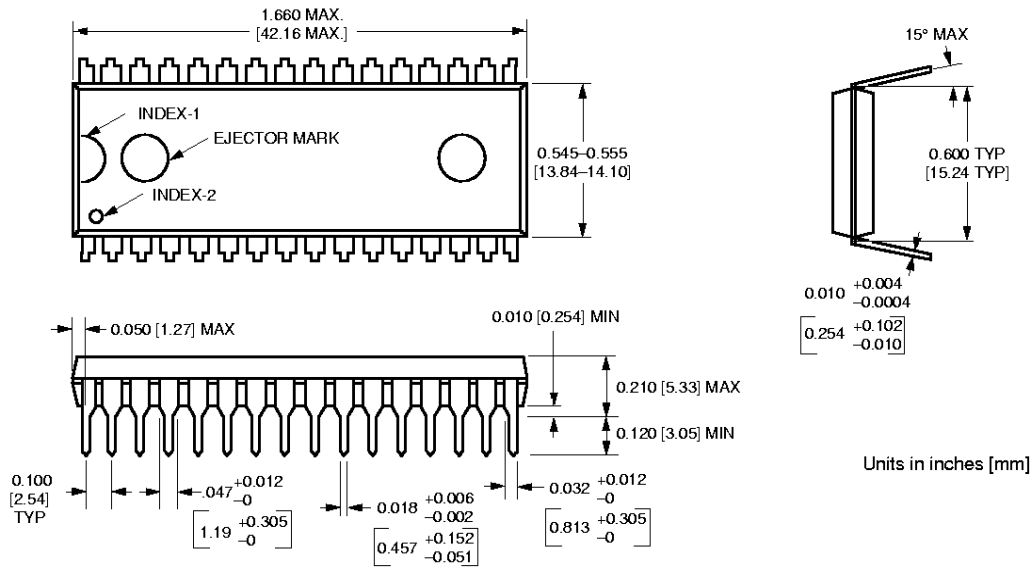
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NOTES:

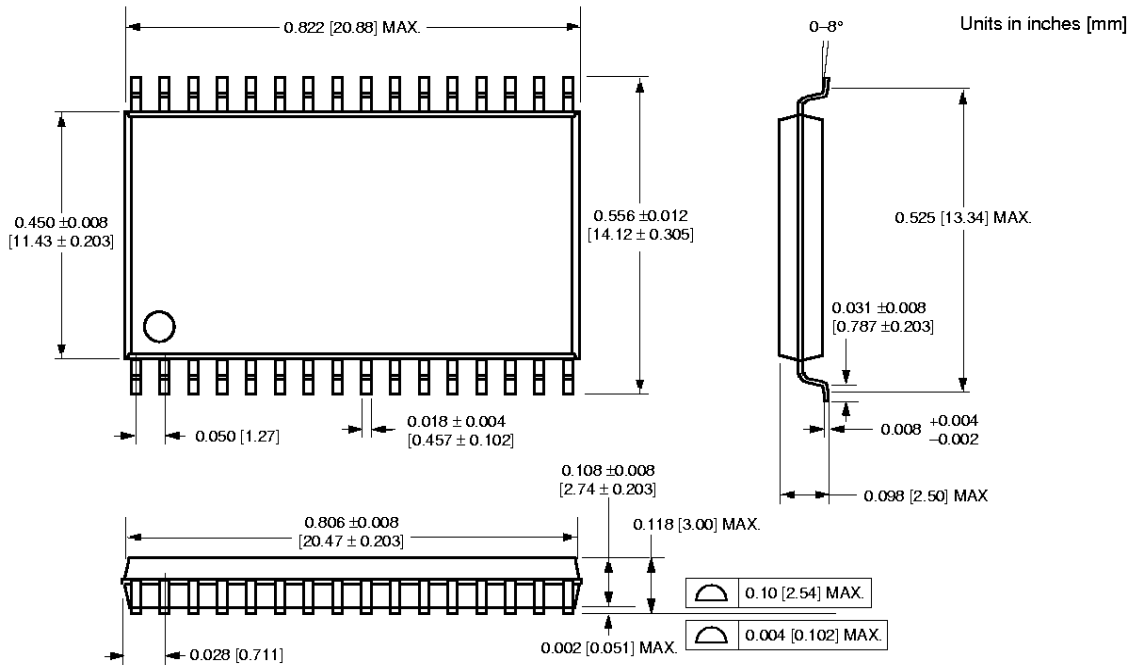
1. $\overline{WE} = V_{IH}$.
2. $\overline{CE}_1 = V_{IL}$ and $CE_2 = V_{IH}$.
3. Address valid prior to or coincident with \overline{CE}_1 transition LOW and/or CE_2 transition HIGH.
4. $\overline{OE} = V_{IL}$.
5. Transition is measured $\pm 500mV$ from steady state with $C_L = 5pF$. This parameter is guaranteed and not 100% tested.

Package Diagrams

32-Pin 600 mil Plastic DIP



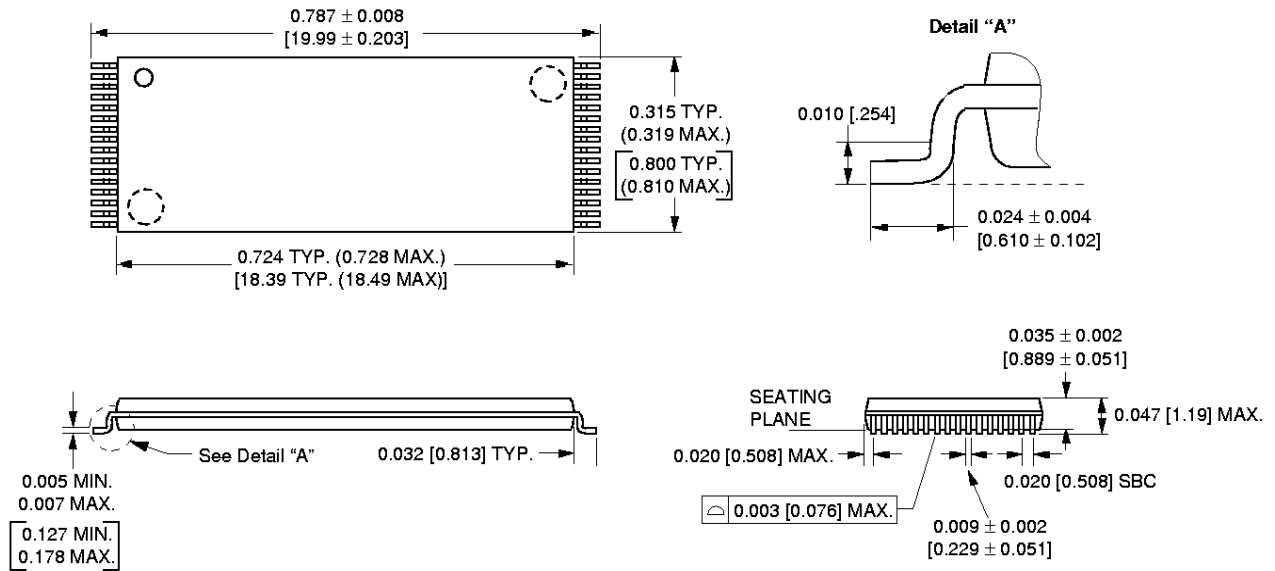
32-Pin 440 mil SOP (525 mil pin-to-pin)



Package Diagrams (Cont'd)

32-Pin TSOP (Standard)

Units in inches [mm]



Notes

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